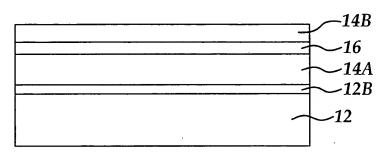
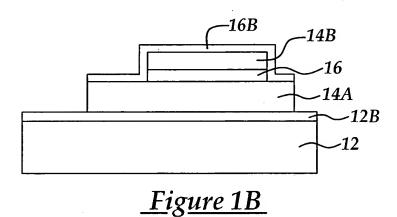
Serial No.: To Be Assigned Filed: Herewith

For: High Density Mim Capacitor Structure And Fabrication Process

Attorney Doc. No.: 67,200-1157



<u>Figure 1A</u>



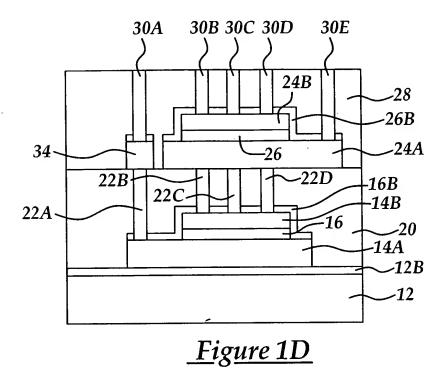
<u>Figure 1C</u>

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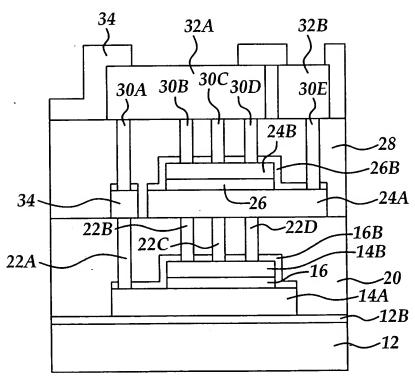
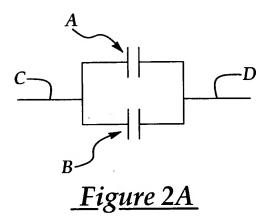
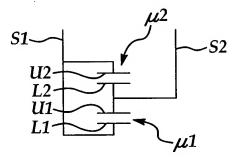


Figure 1E

Inventor: KUAN-LUN CHANG
Serial No.: To Be Assigned Filed: Herewith
For: High Density Mim Capacitor Structure And Fabrication Process

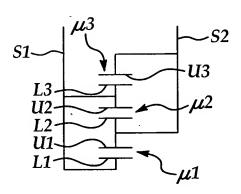
Attorney Doc. No.: 67,200-1157



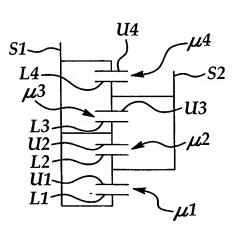


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Figure 2B



<u>Figure 2C</u>



<u>Figure 2D</u>

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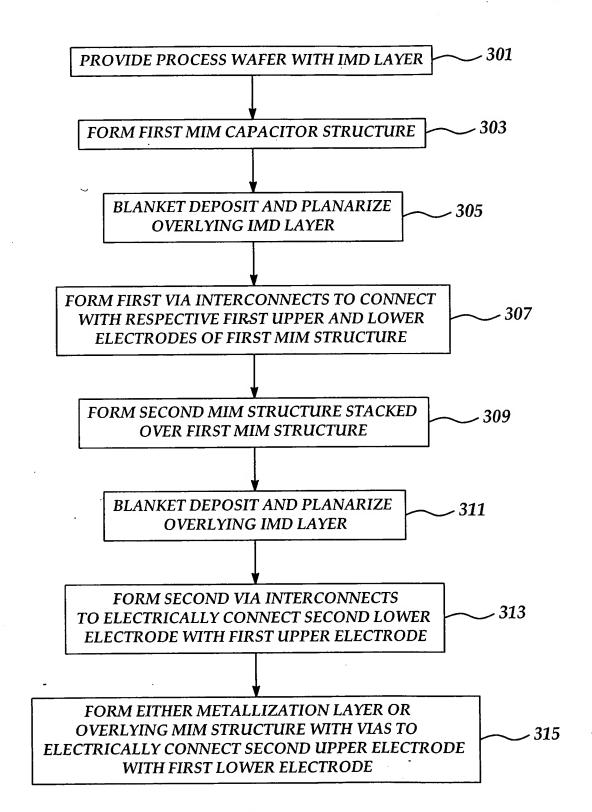


Figure 3